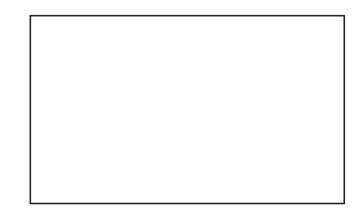


## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10379	REU: A	SUN REV:	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 8/14/2	9:32:39	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10379	REV: A	SUN REV: Not In VersionControl	
	Bottom Overlay <- JACHOI			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 8/14/2	2014 9: 32: 40	AM	TEXAS INSTRUMENTS

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